

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

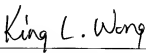
SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT		Docket Number: 12477/13	
Application Number: 10/594,031	Filing Date: September 25, 2006	Examiner: Not Yet Known	Art Unit: 1711
Invention Title: MODIFIER OF POLYESTER RESIN AND PROCESS FOR PRODUCING MOLDED ARTICLE WITH THE SAME		Inventor(s): Kenji Shiga et al.	

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

1. In accordance with their duty of disclosure under 37 C.F.R. § 1.56 and in conformance with the procedures of 37 C.F.R. §§ 1.97 and 1.98, applicants hereby submit the information listed in the attached PTO Form SB/08a. The filing of this Information Disclosure Statement (IDS) and the PTO Form SB/08a, shall not be construed as an admission that the information cited is prior art, or is considered to be material to patentability as defined in 37 C.F.R. § 1.56(b).
2. Applicants note that the Japanese publication cited in the PTO Form SB/08a was previously cited in an Office Action dated April 29, 2008 in a related Korean Patent Application No. 10-2006-7020640.
3. Pursuant to 37 C.F.R. § 1.97(b)(3), no fees are deemed necessary in connection with this IDS. However, should any fees be due, the Commissioner is authorized to charge any such fees to Kenyon & Kenyon LLP Deposit Account No. 11-0600.

Respectfully submitted,
KENYON & KENYON LLP

Date: July 16, 2008



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